Preferred Device

## **Sensitive Gate Silicon Controlled Rectifiers**

#### **Reverse Blocking Thyristors**

Designed and tested for repetitive peak operation required for CD ignition, fuel ignitors, flash circuits, motor controls and low-power switching applications.

#### **Features**

- 150 A for 2 μs Safe Area
- High dv/dt
- Very Low Forward "On" Voltage at High Current
- Low-Cost TO-226 (TO-92)
- Pb-Free Packages are Available\*

MAXIMUM RATINGS (T<sub>J</sub> = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
Peak Repetitive Off–State Voltage (Note 1) (R <sub>GK</sub> = IK, T <sub>J</sub> = $-40$ to $+110$ °C, Sine Wave, 50 to 60 Hz, R <sub>GK</sub> = $1$ k $\Omega$ ) MCR22–6 MCR22–8	V <sub>DRM</sub> , V <sub>RRM</sub>	400 600	V
On–State Current RMS (180° Conduction Angles, T <sub>C</sub> = 80°C)	I <sub>T(RMS)</sub>	1.5	Α
Peak Non-repetitive Surge Current, @T <sub>A</sub> = 25°C, (1/2 Cycle, Sine Wave, 60 Hz)	I <sub>TSM</sub>	15	Α
Circuit Fusing Considerations (t = 8.3 ms)	I <sup>2</sup> t	0.9	A <sup>2</sup> s
Forward Peak Gate Power (Pulse Width $\leq$ 1.0 $\mu$ sec, $T_A$ = 25°C)	P <sub>GM</sub>	0.5	W
Forward Average Gate Power (t = 8.3 msec, $T_A = 25^{\circ}C$ )	P <sub>G(AV)</sub>	0.1	W
Forward Peak Gate Current (Pulse Width ≤ 1.0 µs, T <sub>A</sub> = 25°C)	I <sub>FGM</sub>	0.2	Α
Reverse Peak Gate Voltage (Pulse Width $\leq$ 1.0 $\mu$ s, T <sub>A</sub> = 25°C)	V <sub>RGM</sub>	5.0	V
Operating Junction Temperature Range @ Rated V <sub>RRM</sub> and V <sub>DRM</sub>	TJ	-40 to +110	°C
Storage Temperature Range	T <sub>stg</sub>	-40 to +150	°C

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	50	°C/W
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	160	°C/W
Lead Solder Temperature (Lead Length ≥ 1/16" from case, 10 S Max)	TL	+260	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. V<sub>DRM</sub> and V<sub>RRM</sub> for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; however, positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

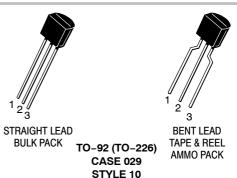


#### ON Semiconductor®

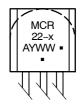
http://onsemi.com

## SCRs 1.5 AMPERES RMS 400 thru 600 VOLTS





#### **MARKING DIAGRAMS**



MCR22-x = Device Code

x = 6 or 8

A = Assembly Location

Y = Year WW = Work Week • Pb-Free Package

(Note: Microdot may be in either location)

PIN ASSIGNMENT		
1	Cathode	
2	Gate	
3	Anode	

#### **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 7 of this data sheet.

**Preferred** devices are recommended choices for future use and best overall value.

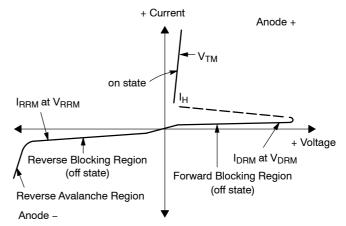
#### **ELECTRICAL CHARACTERISTICS** ( $T_C = 25^{\circ}C$ unless otherwise noted.)

Characteristic	Symbol	Min	Тур	Max	Unit	
OFF CHARACTERISTICS		Cymbol		iyp	Wax	Onit
Peak Repetitive Forward or Reverse Blocking Current ( $V_{AK}$ = Rated $V_{DRM}$ or $V_{RRM}$ ; $R_{GK}$ = 1 k $\Omega$ )	T <sub>C</sub> = 25°C T <sub>C</sub> = 110°C	I <sub>DRM</sub> , I <sub>RRM</sub>	_ _	_ _	10 200	μ <b>Α</b> μ <b>Α</b>
ON CHARACTERISTICS				•	•	
Peak Forward On-State Voltage (Note 2) (I <sub>TM</sub> = 1 A Peak)		V <sub>TM</sub>	-	1.2	1.7	V
Gate Trigger Current (Continuous dc) (Note 3) (V <sub>AK</sub> = 6 Vdc, R <sub>L</sub> = 100 $\Omega$ )	$T_C = 25^{\circ}C$ $T_C = -40^{\circ}C$	I <sub>GT</sub>	- -	30 -	200 500	μΑ
Gate Trigger Voltage (Continuous dc) (Note 3) $(V_{AK} = 7 \text{ Vdc}, R_L = 100 \Omega)$	$T_C = 25^{\circ}C$ $T_C = -40^{\circ}C$	V <sub>GT</sub>	- -	- -	0.8 1.2	V
Gate Non-Trigger Voltage $(V_{AK} = 12 \text{ Vdc}, R_L = 100 \Omega)$	T <sub>C</sub> = 110°C	V <sub>GD</sub>	0.1	-	-	V
Holding Current $(V_{AK} = 12 \text{ Vdc}, R_{GK} = 1 \text{k}\Omega)$ Initiating Current = 20 mA	T <sub>C</sub> = 25°C T <sub>C</sub> = -40°C	I <sub>H</sub>	- -	2.0	5.0 10	mA
DYNAMIC CHARACTERISTICS						
Critical Rate of Rise of Off–State Voltage ( $R_{GK} = 1k\Omega$ ) ( $T_C = 110^{\circ}C$ )		dv/dt	-	25	-	V/μs

Pulse Width = 1.0 ms, Duty Cycle ≤ 1%.
 R<sub>GK</sub> Current not included in measurement.

#### **Voltage Current Characteristic of SCR**

Symbol	Parameter
V <sub>DRM</sub>	Peak Repetitive Off State Forward Voltage
I <sub>DRM</sub>	Peak Forward Blocking Current
$V_{RRM}$	Peak Repetitive Off State Reverse Voltage
I <sub>RRM</sub>	Peak Reverse Blocking Current
$V_{TM}$	Peak on State Voltage
I <sub>H</sub>	Holding Current



#### **CURRENT DERATING**

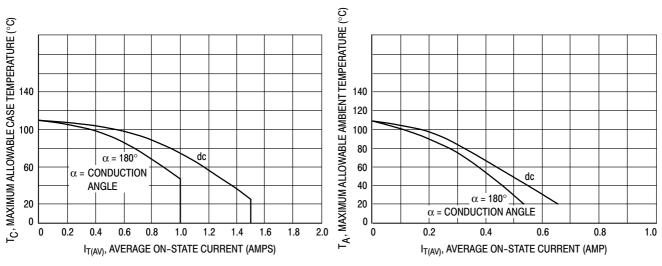
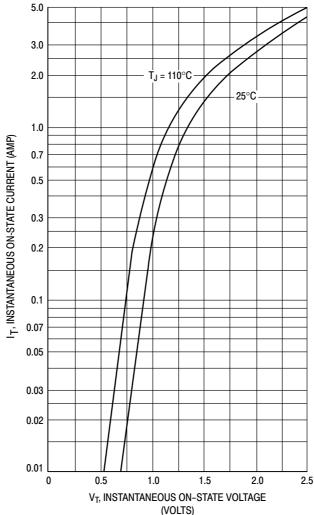


Figure 1. Maximum Case Temperature

Figure 2. Maximum Ambient Temperature



(VOLTS)
Figure 3. Typical Forward Voltage

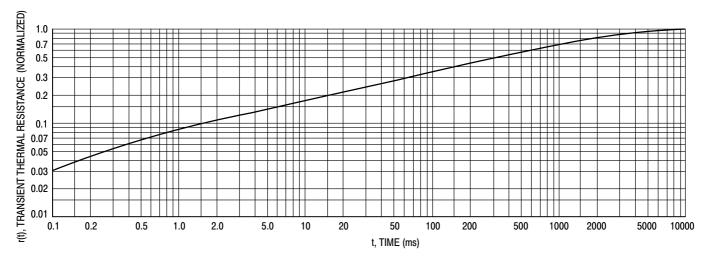


Figure 4. Thermal Response

#### **TYPICAL CHARACTERISTICS**

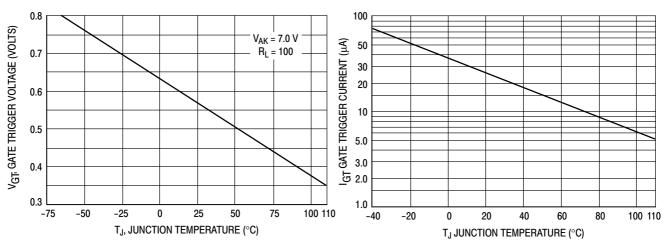


Figure 5. Typical Gate Trigger Voltage

Figure 6. Typical Gate Trigger Current

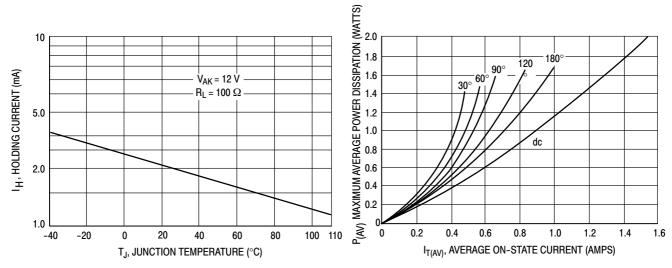


Figure 7. Typical Holding Current

Figure 8. Power Dissipation

#### TO-92 EIA RADIAL TAPE IN FAN FOLD BOX OR ON REEL

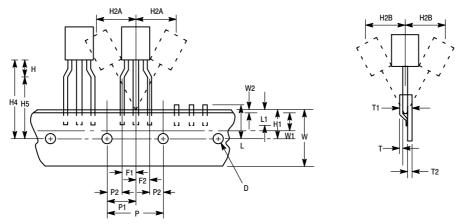


Figure 9. Device Positioning on Tape

			Specif	ication	
		Inches		Millimeter	
Item	Symbol	Min	Max	Min	Max
Tape Feedhole Diameter	D	0.1496	0.1653	3.8	4.2
Component Lead Thickness Dimension	D2	0.015	0.020	0.38	0.51
Component Lead Pitch	F1, F2	0.0945	0.110	2.4	2.8
Bottom of Component to Seating Plane	Н	.059	.156	1.5	4.0
Feedhole Location	H1	0.3346	0.3741	8.5	9.5
Deflection Left or Right	H2A	0	0.039	0	1.0
Deflection Front or Rear	H2B	0	0.051	0	1.0
Feedhole to Bottom of Component	H4	0.7086	0.768	18	19.5
Feedhole to Seating Plane	H5	0.610	0.649	15.5	16.5
Defective Unit Clipped Dimension	L	0.3346	0.433	8.5	11
Lead Wire Enclosure	L1	0.09842	-	2.5	-
Feedhole Pitch	Р	0.4921	0.5079	12.5	12.9
Feedhole Center to Center Lead	P1	0.2342	0.2658	5.95	6.75
First Lead Spacing Dimension	P2	0.1397	0.1556	3.55	3.95
Adhesive Tape Thickness	Т	0.06	0.08	0.15	0.20
Overall Taped Package Thickness	T1	-	0.0567	-	1.44
Carrier Strip Thickness	T2	0.014	0.027	0.35	0.65
Carrier Strip Width	W	0.6889	0.7481	17.5	19
Adhesive Tape Width	W1	0.2165	0.2841	5.5	6.3
Adhesive Tape Position	W2	.0059	0.01968	.15	0.5

#### NOTES:

- 1. Maximum alignment deviation between leads not to be greater than 0.2 mm.
- 2. Defective components shall be clipped from the carrier tape such that the remaining protrusion (L) does not exceed a maximum of 11 mm.
- 3. Component lead to tape adhesion must meet the pull test requirements.
- 4. Maximum non-cumulative variation between tape feed holes shall not exceed 1 mm in 20 pitches.
- 5. Holddown tape not to extend beyond the edge(s) of carrier tape and there shall be no exposure of adhesive.
- 6. No more than 1 consecutive missing component is permitted.
- 7. A tape trailer and leader, having at least three feed holes is required before the first and after the last component.
- 8. Splices will not interfere with the sprocket feed holes.

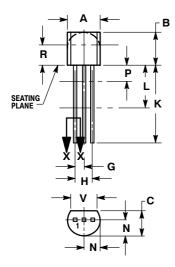
#### ORDERING & SHIPPING INFORMATION: MCR22 Series Packaging Options, Device Suffix

U.S.	Europe Equivalent	Shipping <sup>†</sup>	Description of TO-92 Tape Orientation	
	MCR22-8RL1	0000 / Tana 9 Daal		
	MCR22-8RL1G	2000 / Tape & Reel	Flat side of TO-92 and adhesive tape visible	
MCR22-6				
MCR22-6G		5000 Helle / De	N/A D II	
MCR22-8		5000 Units / Box	N/A, Bulk	
MCR22-8G				
MCR22-6RLRA		0000 / Table 9 Dead	December 170, 00 and adhering large in the	
MCR22-6RLRAG		2000 / Tape & Reel	Round side of TO-92 and adhesive tape visible	
MCR22-6RLRP		2000 / Tono & Amma Dook	Elet side of TO 02 and adhesive tops visible	
MCR22-6RLRPG		2000 / Tape & Ammo Pack	Flat side of TO-92 and adhesive tape visible	

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

#### PACKAGE DIMENSIONS

#### TO-92 (TO-226) CASE 29-11 **ISSUE AM**

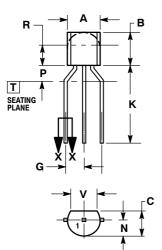


STRAIGHT LEAD **BULK PACK** 



- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: INCH.
- CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED
- LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

	INCHES		MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.175	0.205	4.45	5.20
В	0.170	0.210	4.32	5.33
С	0.125	0.165	3.18	4.19
D	0.016	0.021	0.407	0.533
G	0.045	0.055	1.15	1.39
Н	0.095	0.105	2.42	2.66
J	0.015	0.020	0.39	0.50
K	0.500		12.70	
L	0.250		6.35	
N	0.080	0.105	2.04	2.66
P		0.100		2.54
R	0.115		2.93	
V	0.135		3.43	



**BENT LEAD** TAPE & REEL AMMO PACK



#### NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. CONTROLLING DIMENSION: MILLIMETERS. CONTOUR OF PACKAGE BEYOND
- DIMENSION R IS UNCONTROLLED.
- LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM

	MILLIMETERS		
DIM	MIN	MAX	
Α	4.45	5.20	
В	4.32	5.33	
C	3.18	4.19	
D	0.40	0.54	
G	2.40	2.80	
J	0.39	0.50	
K	12.70		
N	2.04	2.66	
P	1.50	4.00	
R	2.93		
V	3.43		

STYLE 10:

PIN 1. CATHODE GATE

2. 3.

ANODE

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